

RL78/I1C(512KB) FOTA solution

Outline

Highlight

RL78/I1C (512KB) delivers simultaneous operation of microcontroller operations and firmware updates. In the case of smart electricity meters, new firmware can be updated without stopping the metrology operation, and this is the first technology in the industry to solve the problem of billing loss for the amount of electricity used.

Contents

1. What is FOTA?

FOTA is the abbreviation of Firmware update Over-The-Air.

In the Smart Meters or other systems, FOTA becomes more and more necessary to correct a system malfunction due to the software bug after the product has already installed. Furthermore, it is also necessary to add new functions or apply updates to the product in order to follow the market requirements quickly.

Renesas provides Fast FOTA and Continuous Metrology FOTA solutions.

1.1. Fast FOTA

Fast FOTA is a method that updates the firmware with the bank swap function. In the case of electricity meter, the metrology function will stop less than 1 second during the bank swap period. After the firmware update, the meter will restart with the new firmware.

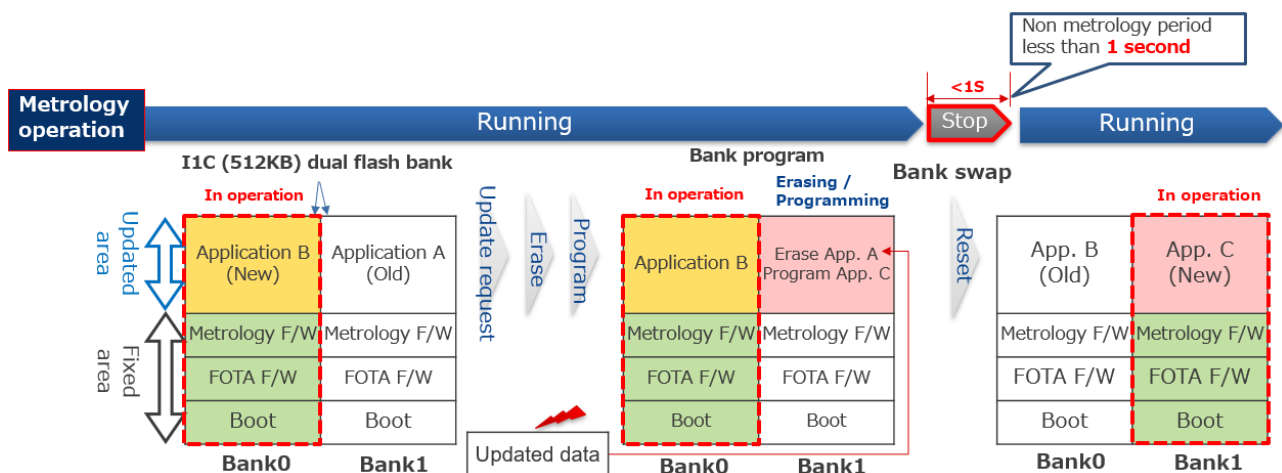


Figure 1: Fast FOTA image

### 1.2. Continuous Metrology FOTA

Continuous Metrology FOTA is the new method that updates the firmware meanwhile the smart meter metrology function still keeps working. With the method, there is no energy accumulation lost even during the bank swap period.

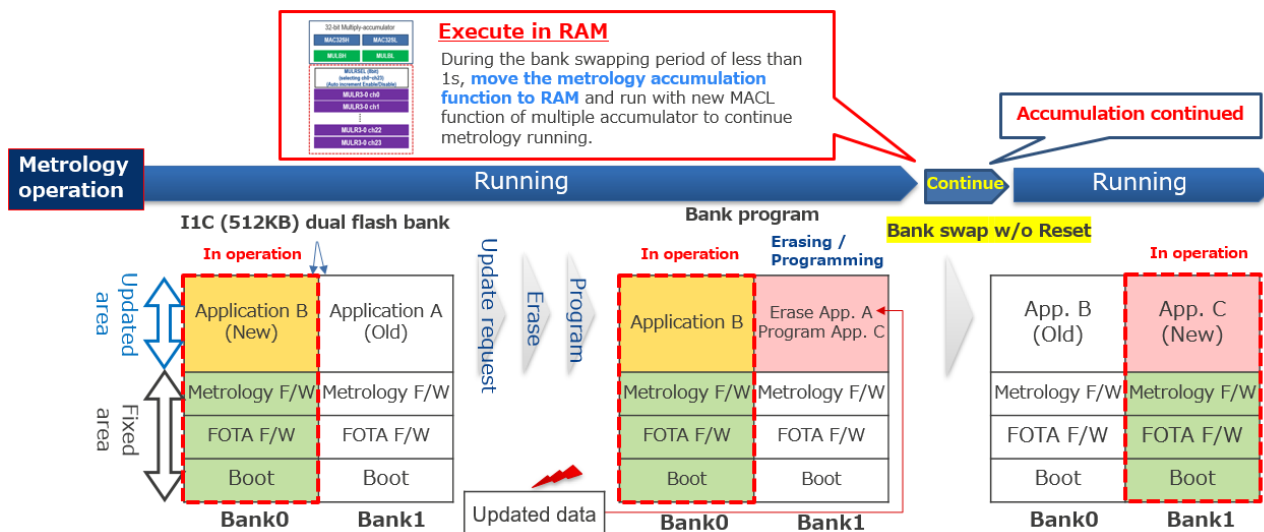


Figure 2: Continuous Metrology FOTA image

### 1.3. Difference between Fast FOTA and Continuous Metrology FOTA

The main difference between the two methods is that the metrology accumulation function still keeps working and there is no energy loss with Continuous Metrology FOTA method.

However, in the case of Continuous Metrology FOTA, user must move certain firmware instructions to RAM to execute continuously.

Renesas will develop the sample codes and prepare the related documents for Fast FOTA and Continuous Metrology FOTA.

## 2. Website and Support

Visit the following URLs to learn about the kit and the RA family of microcontrollers, download tools and documentation, and get support.

- RL78/I1C Resource [renesas.com/br/en/products/microcontrollers-microprocessors/rl78-low-power-8-16-bit-mcus/rl78i1c-ultra-low-power-microcontrollers-high-end-smart-electricity-meter-market](https://www.renesas.com/br/en/products/microcontrollers-microprocessors/rl78-low-power-8-16-bit-mcus/rl78i1c-ultra-low-power-microcontrollers-high-end-smart-electricity-meter-market)
- RL78 Product Information [renesas.com/br/en/products/microcontrollers-microprocessors/rl78-low-power-8-16-bit-mcus](https://www.renesas.com/br/en/products/microcontrollers-microprocessors/rl78-low-power-8-16-bit-mcus)
- RL78 Knowledge Base [en-support.renesas.com/knowledgeBase#31025](https://en-support.renesas.com/knowledgeBase#31025)
- Renesas Support [en-support.renesas.com/dashboard](https://en-support.renesas.com/dashboard)

**Revision History**

| Rev. | Date                        | Description |                 |
|------|-----------------------------|-------------|-----------------|
|      |                             | Page        | Summary         |
| 1.00 | May 19 <sup>th</sup> , 2021 | -           | Initial release |
|      |                             |             |                 |

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

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